



MAPCGM0003-DIE RO-P-DS-3045 A Preliminary Information

#### **Features**

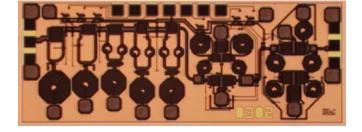
- ♦ 6 Bit Phase Shifter (0° ~ 354°, CW)
- TTL Control Inputs
- MSAG<sup>™</sup> Process

### **Description**

The MAPCGM0003-Die is a 6-bit Phase Shifter with Parallel Input Control. This product is fully matched to 50 ohms on both the input and output. It can be used to obtain a phase shift of 5.6° to 354° Clockwise.

Fabricated using M/A-COM's repeatable, high performance and highly reliable GaAs Multifunction Self-Aligned Gate MESFET Process, each device is 100% RF tested on wafer to ensure performance compliance.

M/A-COM's MSAG<sup>™</sup> process features robust silicon-like manufacturing processes, planar processing of ion implanted transistors, multiple implant capability enabling power, low-noise, switch and digital FETs on a single chip, and polyimide scratch protection for ease of use with automated manufacturing processes. The use of refractory metals and the absence of platinum in the gate metal formulation prevents hydrogen poisoning when employed in hermetic packaging.



#### **Primary Applications**

- Satellite Communication
- Phased Array Radar

Parameter	Symbol	Typical	Units
Bandwidth	f	2.3-4.1	GHz
Insertion Loss	IL	5.7	dB
Input VSWR (At Reference)	VSWR	1.5:1	
Output VSWR (At Reference)	VSWR	1.2:1	
RMS Phase Error	RMS	6	o
Phase Range	$\Delta \Phi$	354	o
Gain Variation over all Phase Shifter settings	ΔG	< 3	dB
Source Current	I <sub>EE</sub>	< 10	mA
Input Third Order Intercept	ΙΤΟΙ	36	dBm
Input 1-dB Compression Point	$P_{1dB}$	23	dBm

#### Electrical Characteristics: $T_B = 40^{\circ}C^1$ , $Z_0 = 50\Omega$ , $V_{EE} = -5V$

#### 1. T<sub>B</sub> = MMIC Base Temperature

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# Maximum Operating Conditions<sup>1</sup>

Parameter	Symbol	Absolute Maximum	Units
Input Power	P <sub>IN</sub>	30	dBm
Source Supply Voltage	V <sub>EE</sub>	-4.8	V
Source Current (No RF)	I <sub>EEQ</sub>	20	mA
Junction Temperature	Tj	180	۵°
Storage Temperature	T <sub>STG</sub>	-55 to +150	°C

1. Operation outside of these ranges may reduce product reliability. Operation at other than the typical values may result in performance outside the guaranteed limits.

## **Recommended Operating Conditions**

Characteristic	Symbol	Min	Тур	Max	Unit
Source Voltage	V <sub>EE</sub>	-5.2	-5	-4.8	V
Control Voltage	V control pads				
Logic High		3	5	5	V
Logic Low		0	0	0.4	V

### **Operating Instructions**

This device is static and light sensitive. The digital circuitry operation can be impaired under high intensity light, e.g. microscope light. Please handle with care. To operate the device, follow these steps.

- 1. Power Up: Apply  $V_{EE} = -5 V$ .
- 2. Apply Logic Voltages to control Circuits as listed in Recommended Operating Conditions
- 3. Power Down: Set  $V_{EE} = 0$

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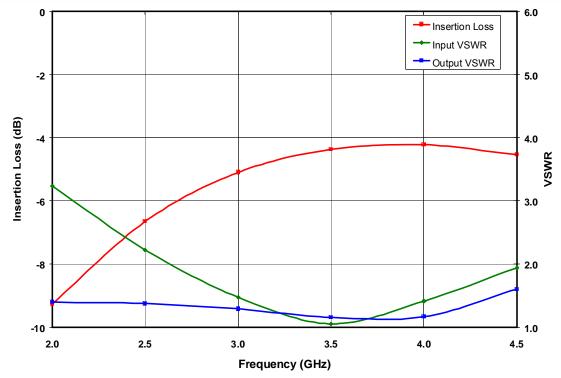


Figure 1. Reference State Insertion Loss, Input and Output VSWR vs. Frequency

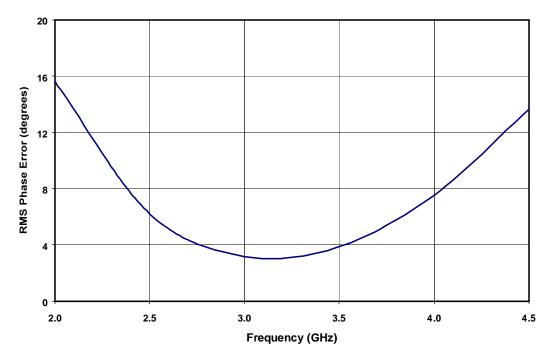


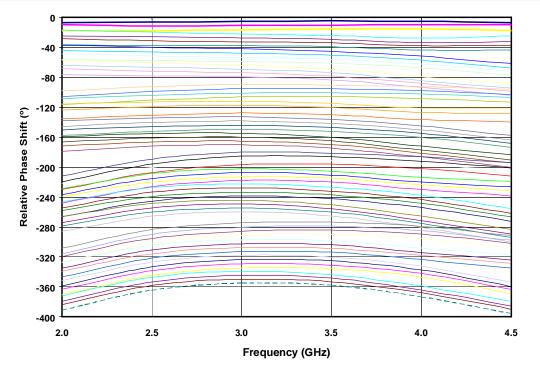
Figure 2. Uncorrected RMS Phase Error Over All Phase States vs. Frequency

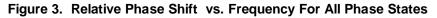
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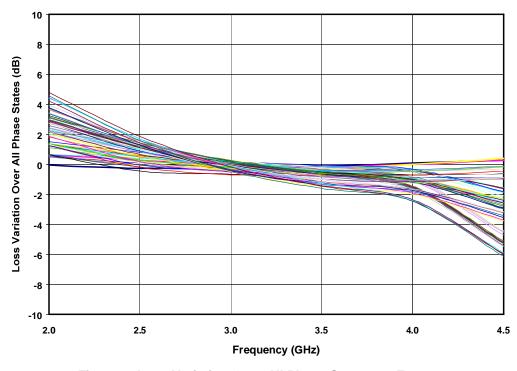




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Figure 4. Loss Variation Over All Phase States vs. Frequency

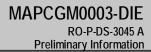
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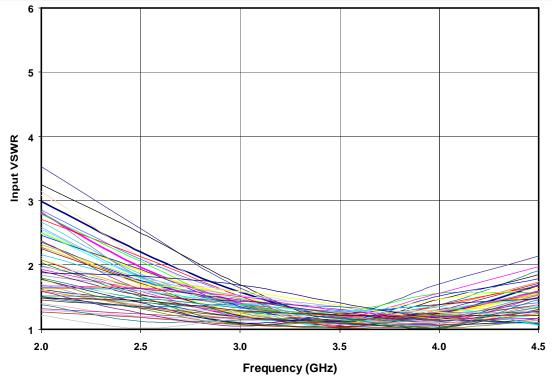
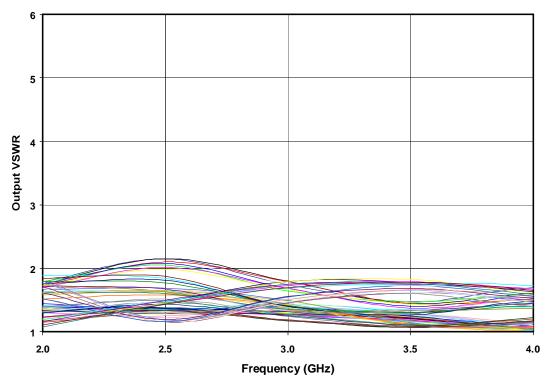


Figure 5. Input VSWR Over All Phase States vs. Frequency



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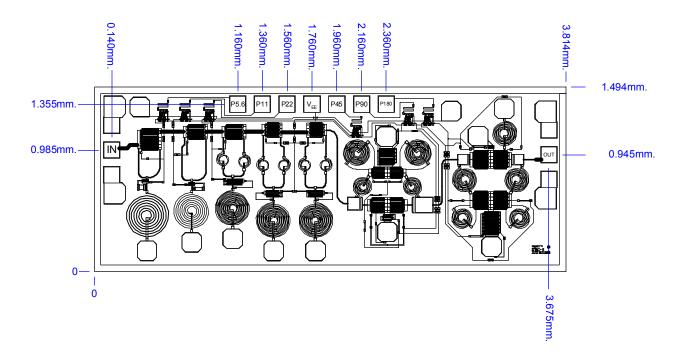




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# Mechanical Information

Chip Size: 3.814 x 1.355 x 0.075 mm (150 x 55 x 3 mils)





## **Bond Pad Dimensions**

Pad	Size (μm)	Size (mils)
RF In and Out	100 x 200	4 x 8
DC Supply Voltage VEE	125 x 125	5 x 5
DC Control Voltage VC	125 x 125	5 x 5

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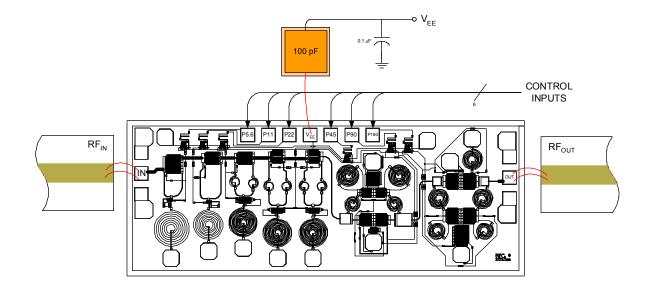
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**Figure 6. Recommended bonding diagram** for pedestal mount. Support circuitry typical of MMIC characterization.

#### **Assembly Instructions:**

Die attach: Use AuSn (80/20) 1-2 mil. preform solder. Limit time @ 300 °C to less than 5 minutes.

**Wirebonding:** Bond @ 160 °C using standard ball or thermal compression wedge bond techniques. For DC pad connections, use either ball or wedge bonds. For best RF performance, use wedge bonds of shortest length, although ball bonds are also acceptable.

Biasing Note: Must apply negative bias to V<sub>EE</sub> before applying positive bias to Control Pads.

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